



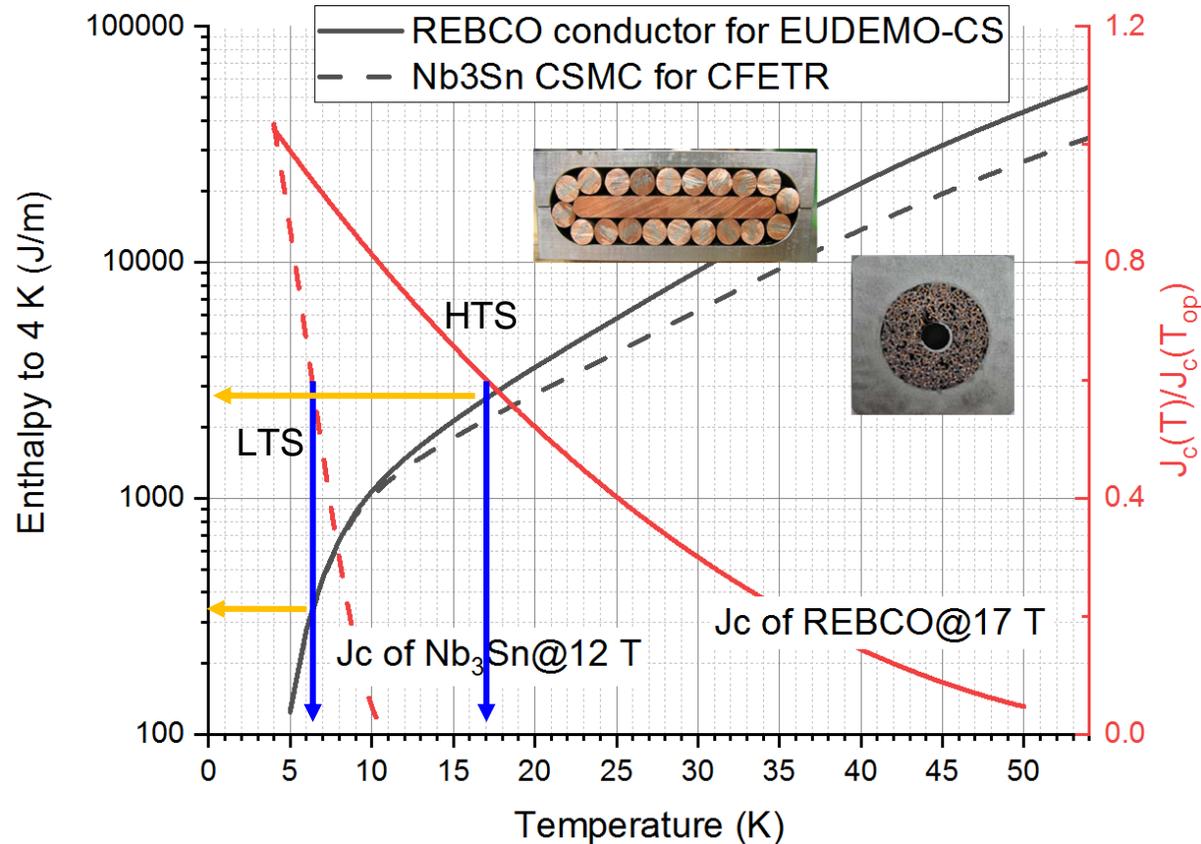
Modelling quench in a 50 kA REBCO conductor with twisted-soldered-stacked strands

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11.07.2019

Szczecin

1. Why quench behavior of HTS is important?



High T_{cs} is easily accessible with HTS:

HTS conductor can be designed much more stable than LTS.

→ Difficult to quench

Quench protection is still needed considering the enormous cost once the magnet damages by unrecoverable quench.

Quench propagation of HTS is significantly slower than LTS: cm/s V.S. m/s.

→ Difficult to detect quench

→ May get high hot spot temperature

Understand quench behavior of HTS conductor is important.

2. What do we need to study for HTS conductor?



From the perspective of (fusion) conductor design:

- How long it takes from a local quench initiation to detection (NZPV)
- How high the hot spot temperature will be (T_{\max})

with the given parameters:

- 1) detection voltage
- 2) delay time for quench validation and protection system activation;
- 3) discharge time constant

An accurate quantitative study is needed to give some convincing values.

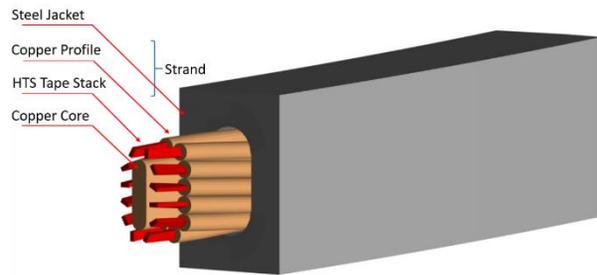
=> Simulation is the cheap and easy way.

3. What kind of simulation model works?



- The 1-D numerical model (e.g. THEA) was well verified for LTS CICCs.
- The physical principles for HTS are the same (to solve thermal, electrical and hydraulic equations).

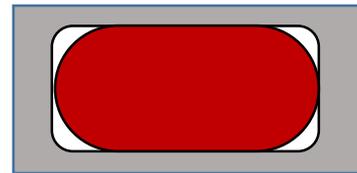
However, what could be different is: **The proper simplification for an 1-D model**



Features:

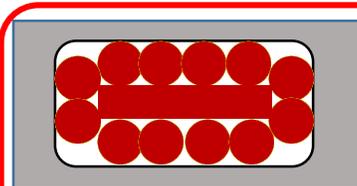
- **Multi-stage coupling:**
 - Tape to tape
 - Tape to copper profile
 - Strand to strand
 - Strand to core
 - Strand to jacket

- **Anisotropic J_c**



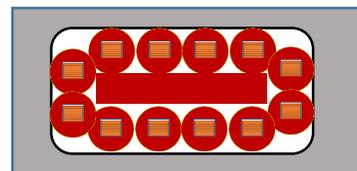
Single cable model:

Assume perfect coupling in cable (porosity).
validated for LTS CICC.



Multi-monolithic strand model:

Assume perfect coupling inside strand. Inter-strand coupling (heat transfer and current sharing) is calculated.
Achieved with THEA. To be benchmarked.



(Quasi-)3D model:

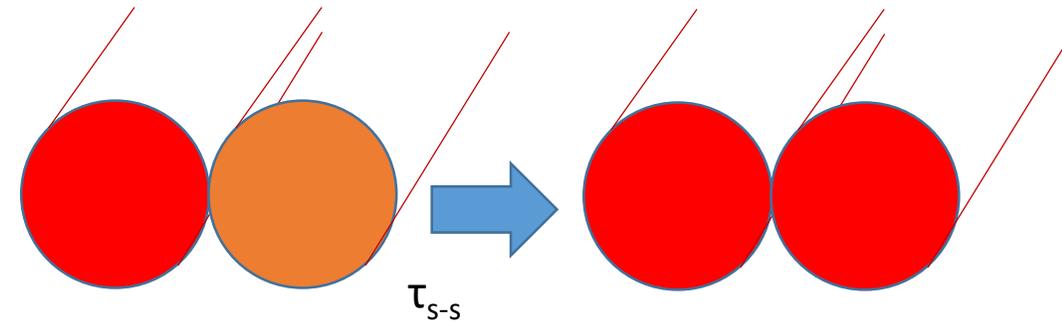
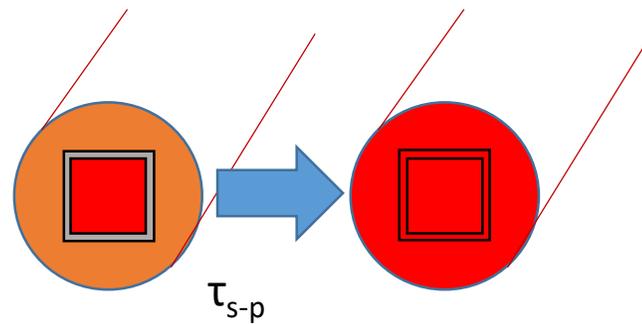
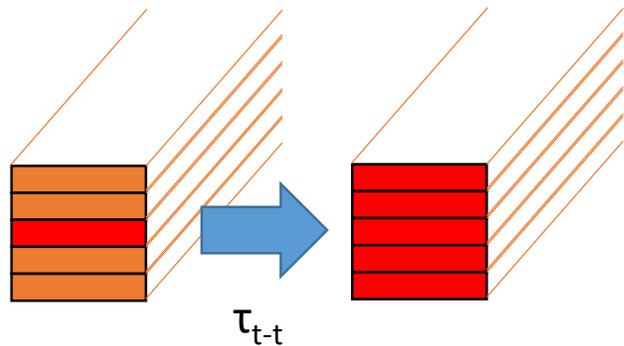
Each tape is modeled. Coupling of tape to tape and tape to copper profile are calculated. Could be achieved with commercial FEM software.

4. How to benchmark the model



Two approaches:

- Compare the predication of simulation with experimental results
 - *Quench experiment on 15 kA level HTS conductors will be implemented at SULTAN around these two years.*
- Figure out at which condition the monolithic strand assumption is valid with simulation
 - *The time scale for current redistribution and heat transfer:*



$$\tau_{s-s} > \tau_{s-p} \quad ?$$
$$\tau_{s-s} > \tau_{t-t} \quad ?$$

5. Critical current



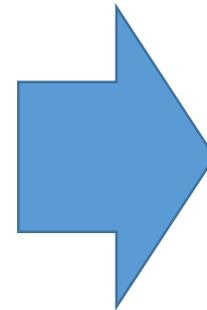
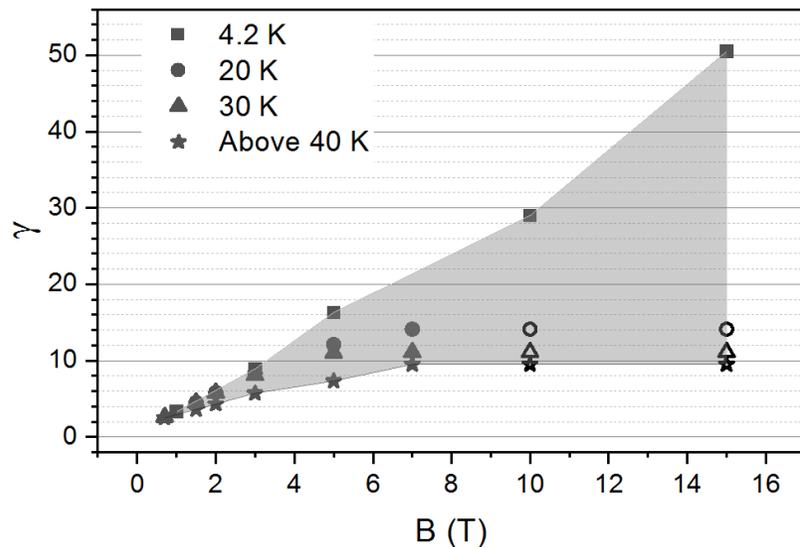
$$J_c(B_{\perp}, T, \theta) = J_{c\perp}(B_{\perp}f(\theta), T)$$

$$f(\theta) = \sqrt{\cos^2\theta + \gamma^{-2}\sin^2\theta}$$

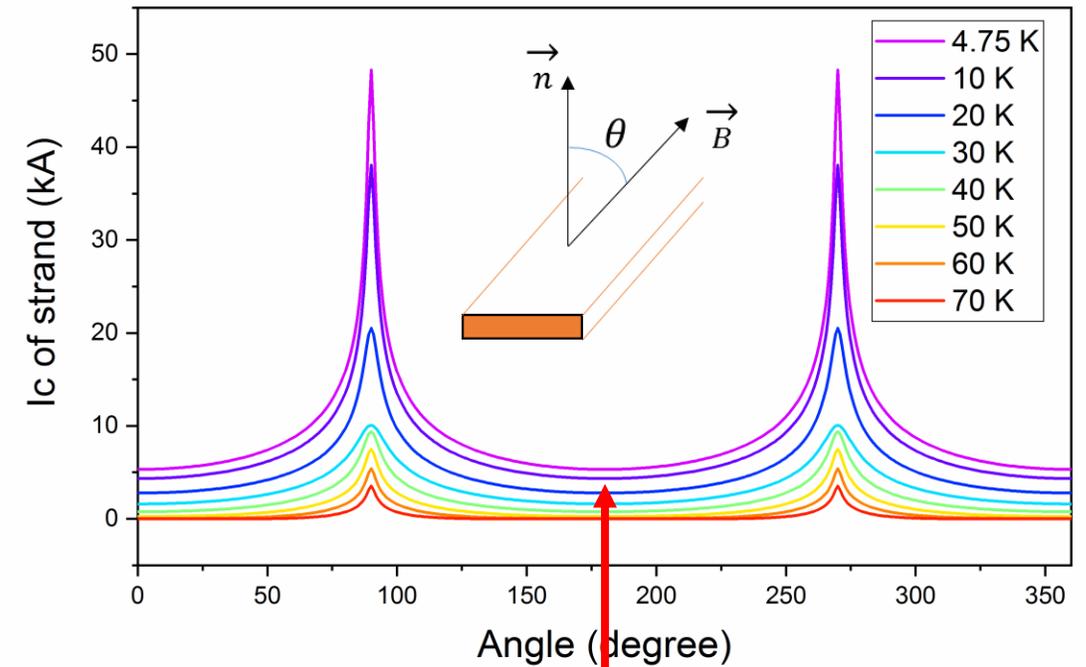
$$J_{c\perp}(B_{\perp}, T) = A \left(\frac{B_0(T)^\beta}{B} \right) \left(\frac{B}{B_0(T)} \right)^p \left(1 - \frac{B}{B_0(T)} \right)^q$$

$$B_0(T) = B_0(0) \left(1 - \frac{T}{T_0} \right)^\alpha$$

$B_0(0)$ [T]	T_0 [K]	A [$\text{MA} \cdot \text{T}^{1-\beta}/\text{m}^2$]	α	β	p	q
170.78	138.91	836	3.48	1.61	0.54	2.82

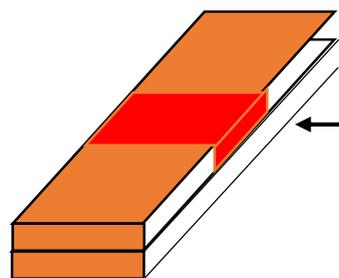


Critical current of one strand at 17.5 T



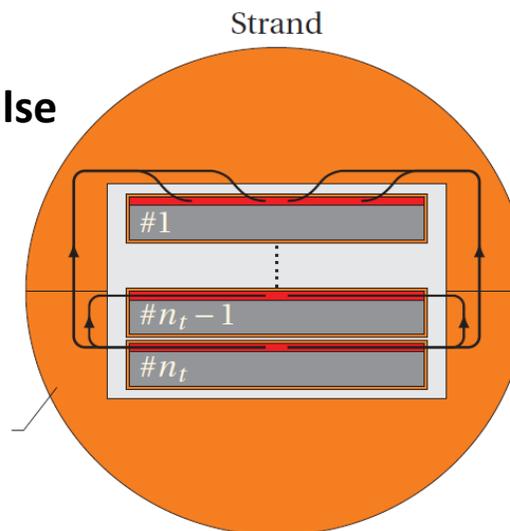
Quench will be initiated here

6. Inter-tape coupling



Heat pulse at one tape
1 cm & 1 ms, 100 W/m
(adiabatic)

Solid lines: tape with heat pulse
Dash lines: tape without heat pulse



Copper

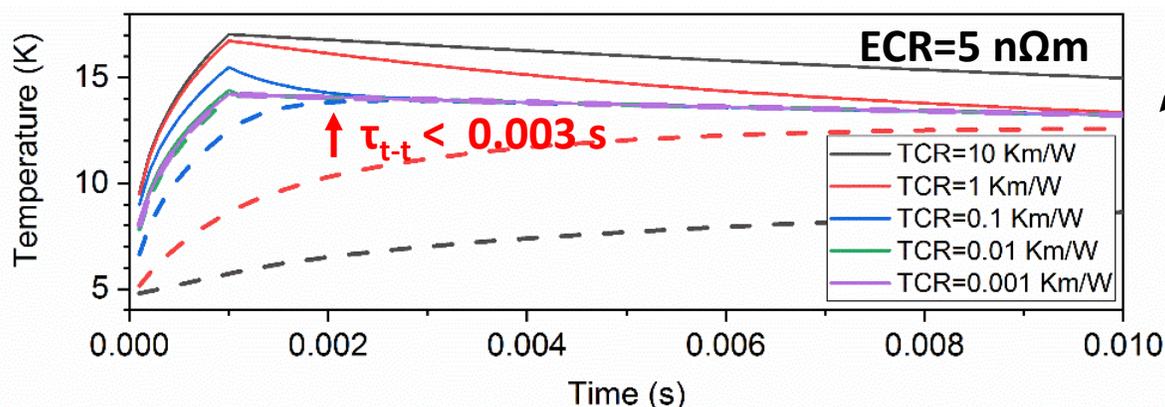
ECR ~ 5 nΩm at 5 K for any two tapes
(measured and deduced [1])

TCR ~ 0.1 Wm/W for adjacent two tapes
(measured [2])

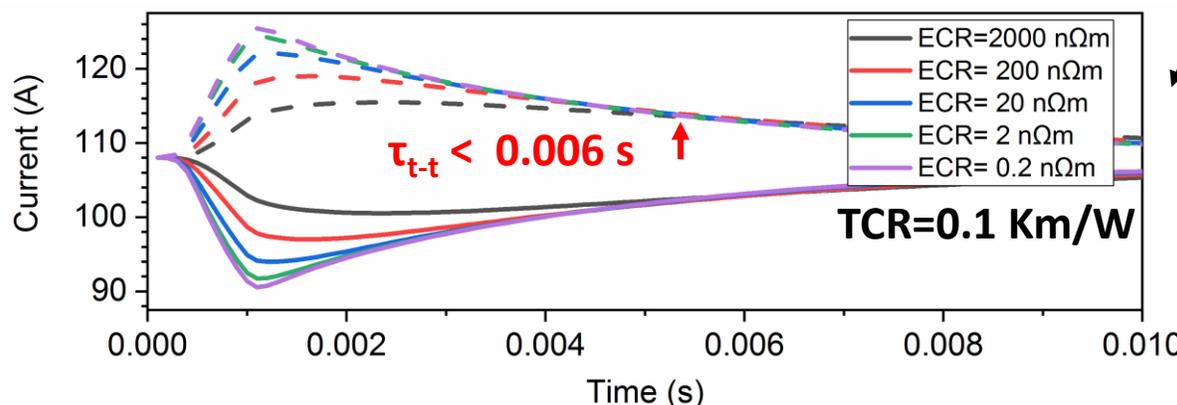
Heat will also transfer to solder and copper profile

- For electrical coupling, τ_{t-t} is in the magnitude of ms in a soldered strand for any two tapes.
- For thermal, it is in the magnitude of ms for adjacent tapes.
- For other two tapes?

Temperature at tape center V.S. thermal contact resistance (TCR)



Current at tape center V.S. electrical contact resistance (ECR)



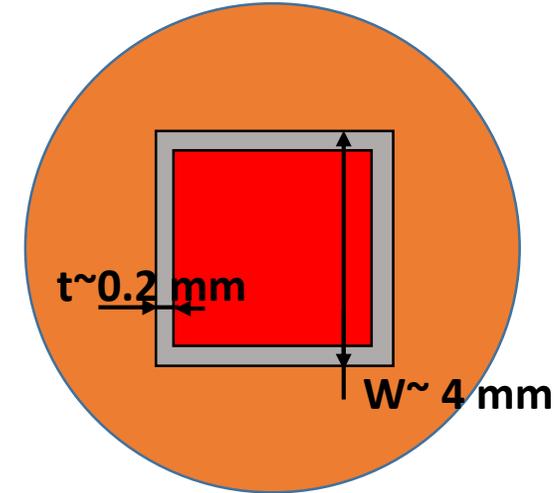
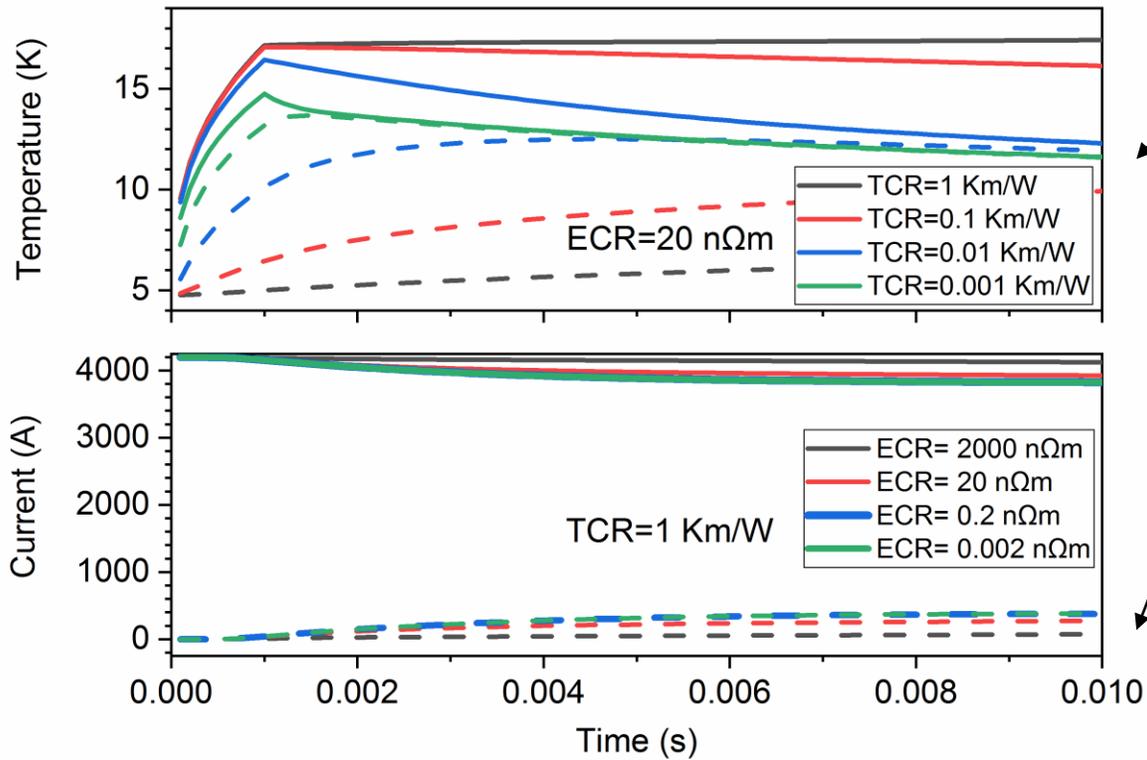
[1] N. Bykovsky, "HTS high current cable for fusion application," PhD, EPFL, 2017. 7/14
[2] Bonura, M. and C. Senatore (2015). "Transverse Thermal Conductivity of REBCO Coated Conductors"

7. Stack-profile coupling



Solid lines: tape stack
Dash lines: copper profile

Temperature and current at strand center V.S. TCR and ECR

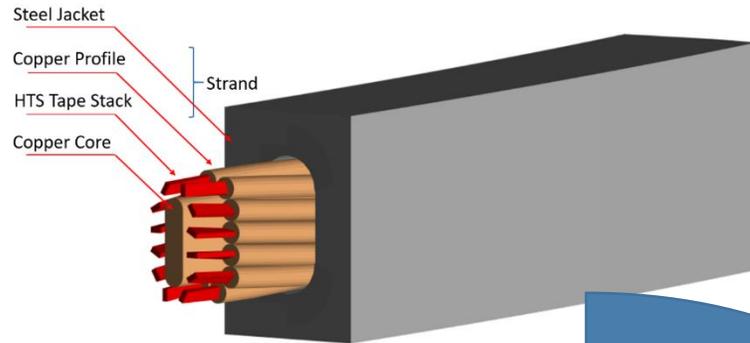


Assume the resistance between REBCO stack and copper profile is mainly contributed by the soldered

- $ECR \sim \rho_{sd} \cdot t / (4 \cdot w) \sim 0.04 \text{ n}\Omega\text{m}$
- $TCR \sim t / (4 \cdot w \cdot k_{sd}) \sim 0.0008 \text{ Km/W}$

➔ τ_{s-p} is in the magnitude of ms in a soldered strand

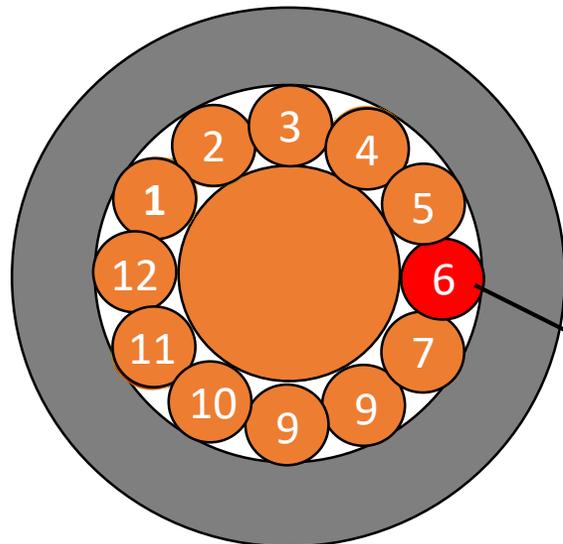
8. Conductor model



150 m

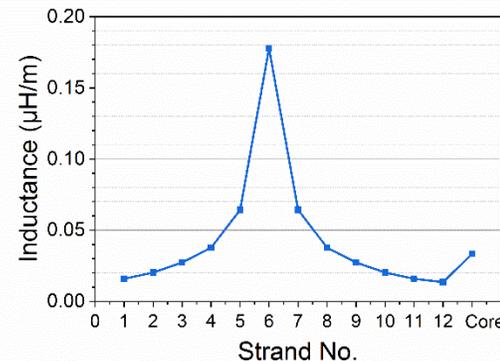
Modelling

Neglect twist of cable



Topological in round shape

Inductance Matrix of strand 6



Parameter	Full-size Conductor
Operating temperature (K)	4.75
Operating current (kA)	50.9
Maximum magnetic field (T)	17.5
Current sharing temperature (K)	~10.5
Number of strands	12
Strand diameter (mm)	7.5
Number of REBCO tapes in each strand	42
Tape width (mm)	4
Tape thickness (mm)	0.095
Fraction of tape composition: REBCO: Cu: Hastelloy: Ag	1:40:50:4
Copper (RRR=30) area in each strand (mm ²)	32
Copper area in core (mm ²)	189
Steel area (mm ²)	2588
Helium area (mm ²)	151
Hydraulic diameter (mm)	1.52
Helium inlet pressure (bar)	6
Twist pitch of tape stack (m)	0.4
Orientation of stacks between two neighbor strands (°)	30

9. Quench by transient local disturbance



Disturbance spectrum at superconducting magnet *

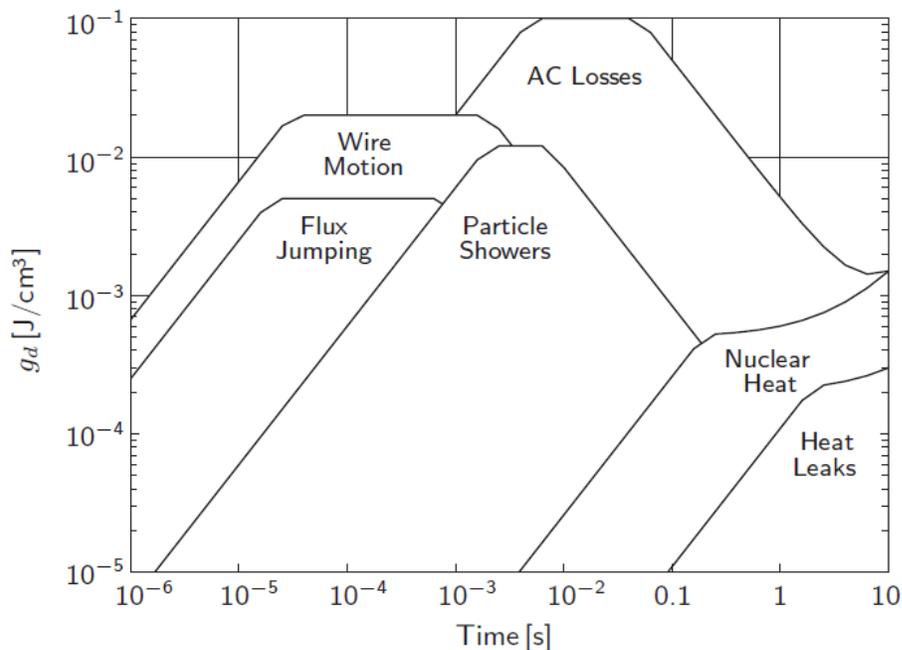


Fig. 6.1 Spectra of $g_d(t)$ compiled for LTS magnets [6.14].

Possible transient local disturbance: strand movement.

➤ Might be easier to happen than in LTS since cable is less rigid with longer twist pitch.

The disturbance energy (density) can be estimated as:

$$q = \frac{c \cdot I \cdot B \cdot l \cdot \Delta x}{l \cdot A}$$

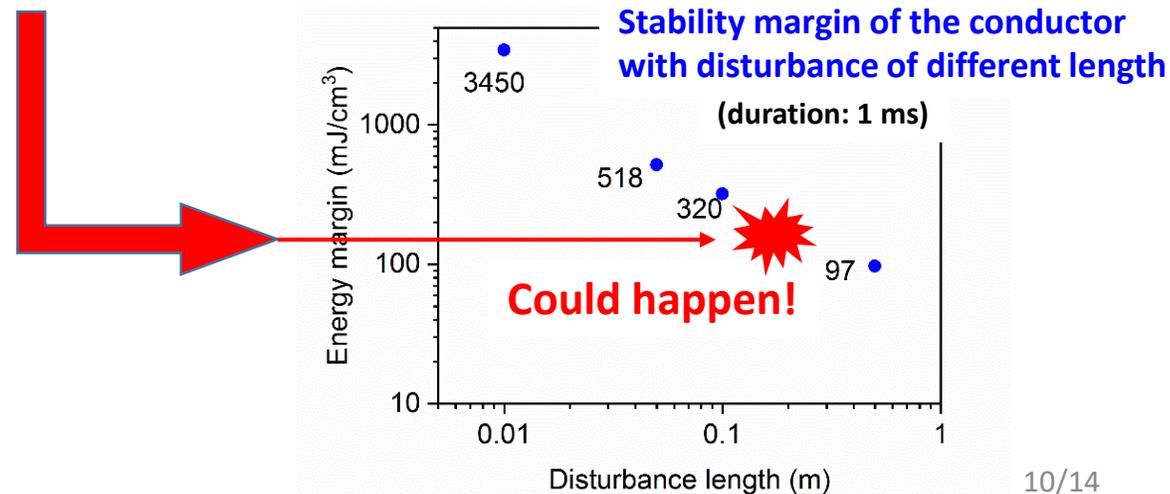
For one strand

- Operating current (I)=4250 A
- Peak magnetic field (B)= 17.5 T
- Cross section (A)= 44 mm²

Assume

- Displacement (Δx)=1 mm
- Proportion of heat deposition and work (c)=10%

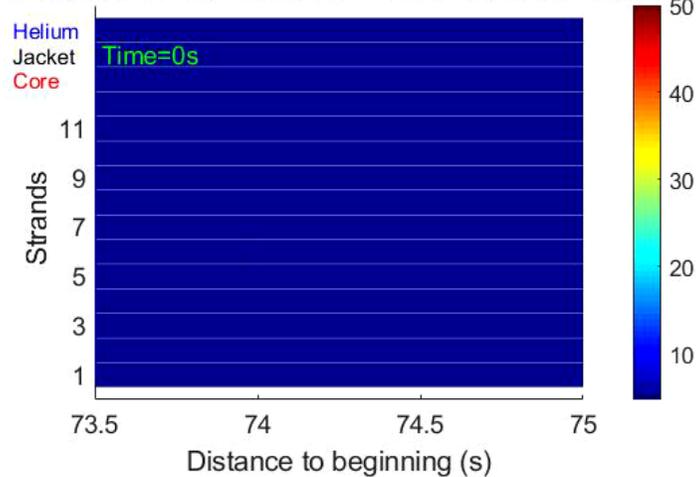
➔ $q = 169 \text{ mJ/cm}^3$



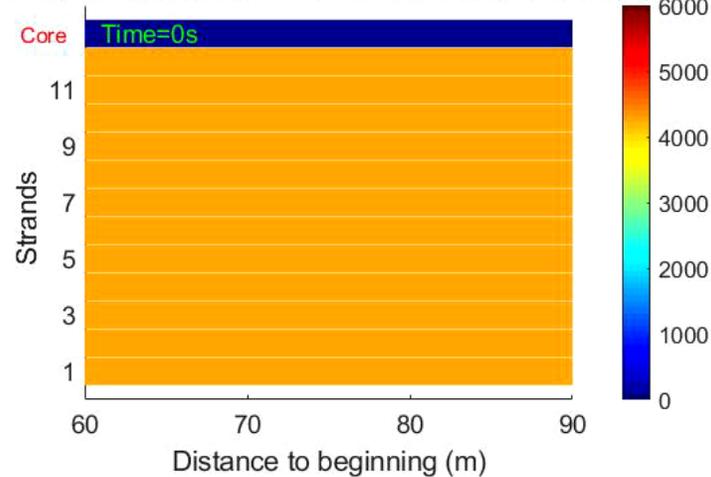
10. Quench Propagation



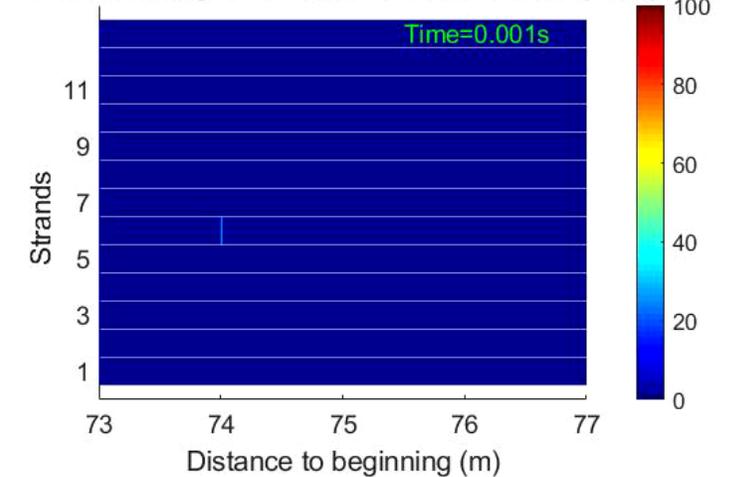
Temperature evolution of conductor components



Current evolution of conductor components (A)



Joule heating of conductor components (W/m)



Significant change happens in 10 ms, $> \tau_{t-t}$ and τ_{s-p}

ECR=2 $\mu\Omega$ m TCR=1 Km/W

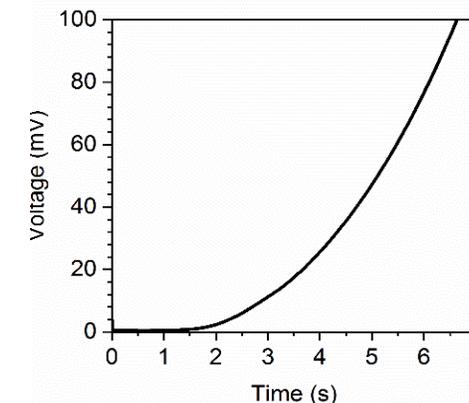
Influenced by helium flow, quench mainly propagates along downstream direction, with average velocity of 140 mm/s.

Fast or slow?

→ Assume 1.1 s for quench protection system validating and activating and 20 s as the time constant for dumping current exponentially, the hot spot temperature at strand will go to 120 K*.

Criteria for strands: 200 K

Voltage of the conductor

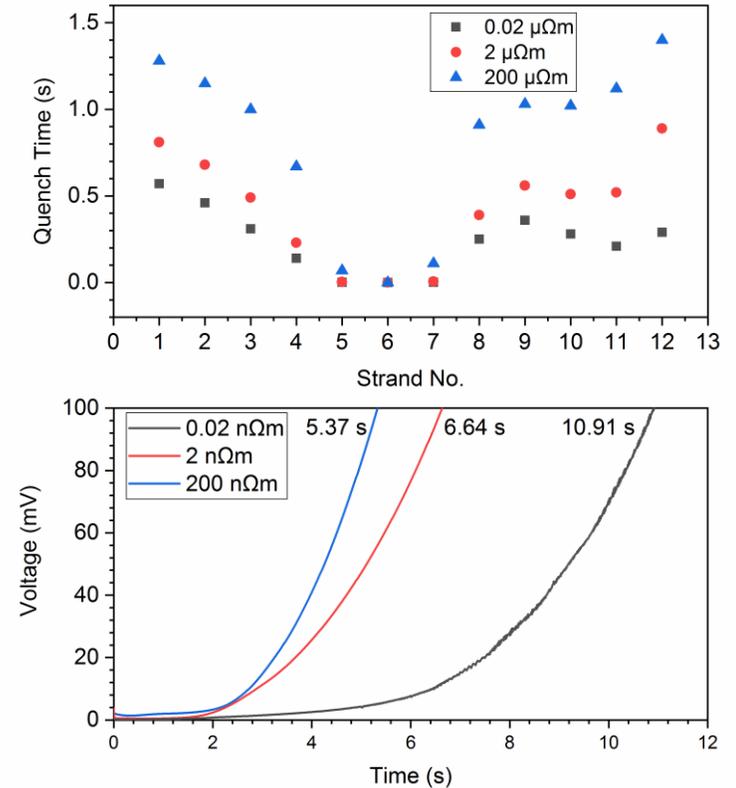
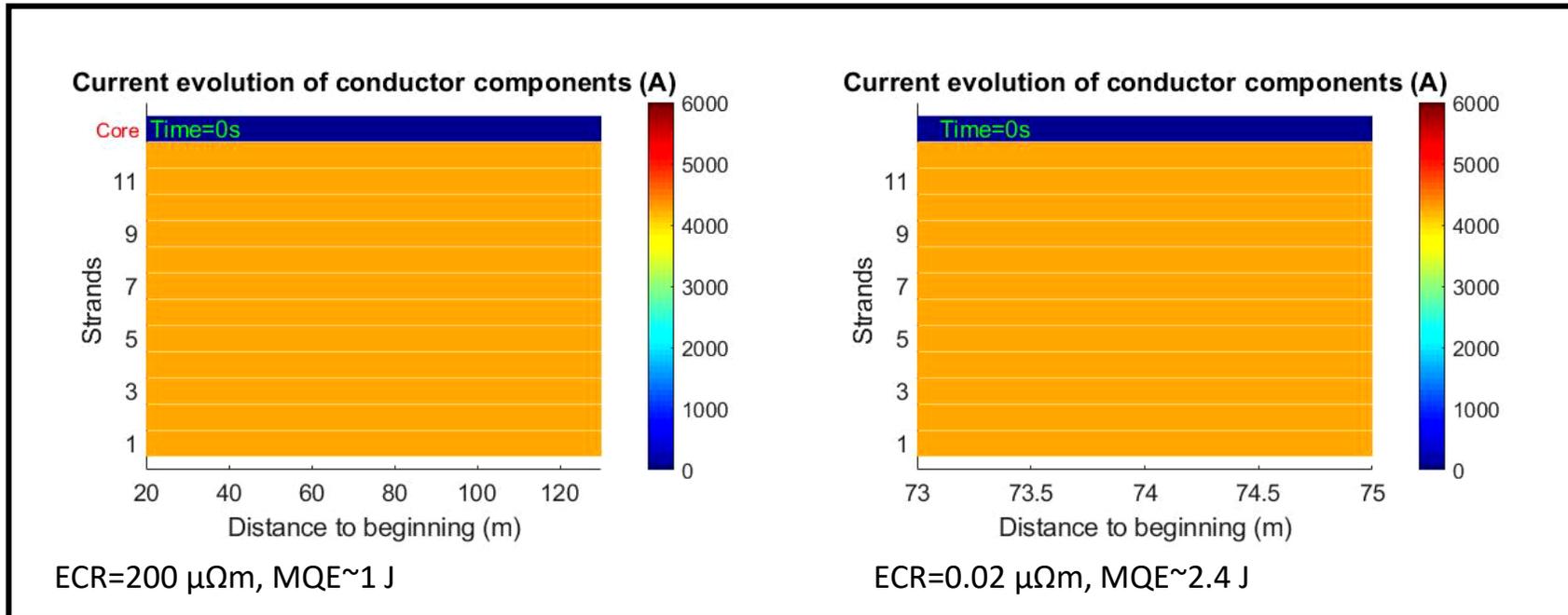


11. Influence of inter-strand resistance



Two motivations:

- In real conductor, it may vary in the manufacturing process.
- An important parameter for optimization of conductor: coupling loss.



Both transverse and longitudinal quench propagation are influenced.

Hot spot temperature at strand: \sim 200 K for ECR=200 $\mu\Omega\text{m}$ and 120 K for ECR=0.02 $\mu\Omega\text{m}$

→ Differs with what was observed on sub-scale conductor*.

12. Summary and outlook



Summary:

- The monolithic strand is a good assumption of the twisted-soldered-stacked REBCO strand for quench modelling.
- Strand movement might be one source of transient local quench, which can be perfectly simulated with the multi-monolithic strand model.

Outlook:

Parametric study to optimize the conductor in view of quench behavior:

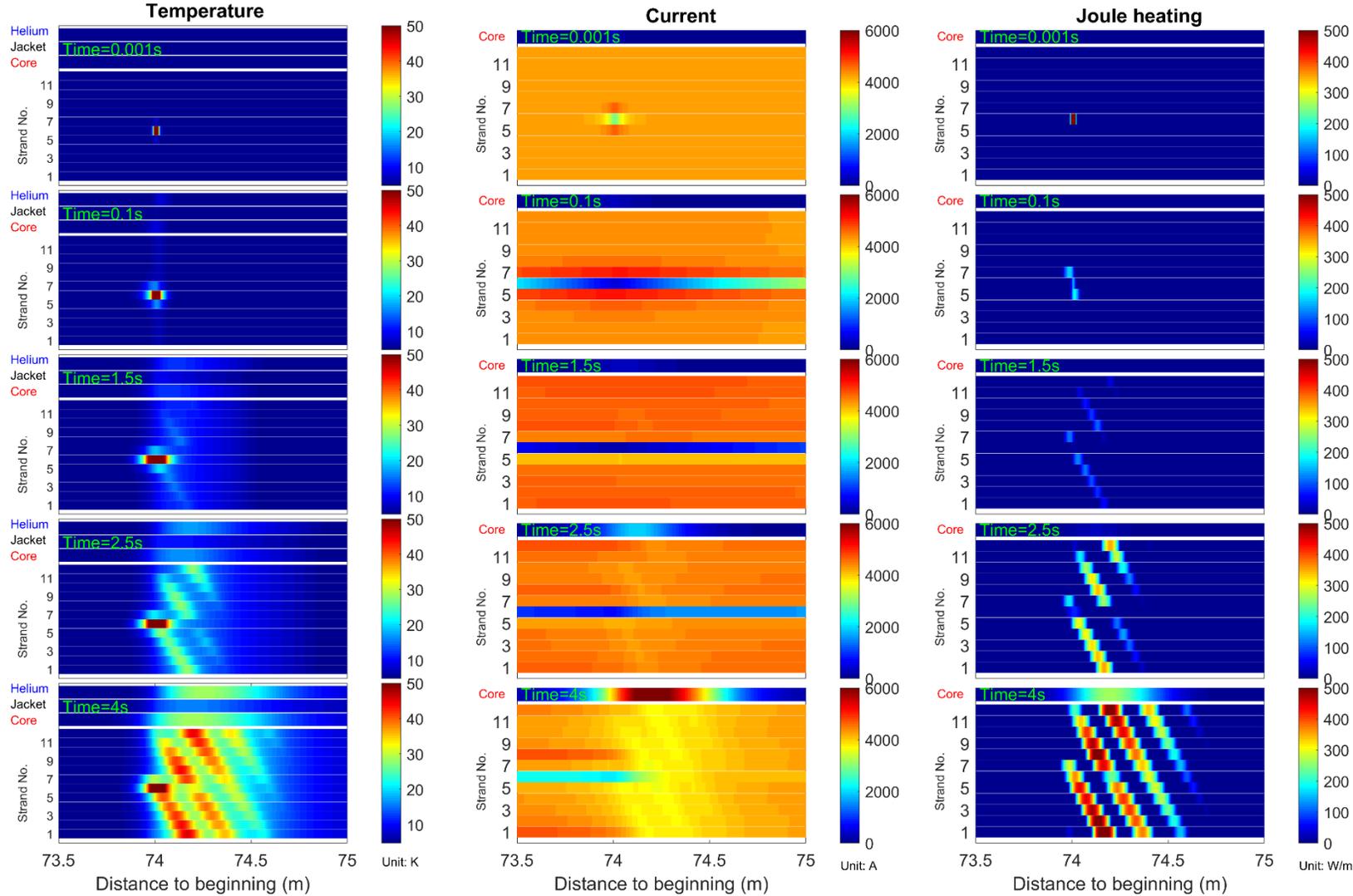
- Strand (stack) orientation
- Twist pitch of stack (and cable)
- Inter-strand resistance
- T_{cs}
- RRR
-



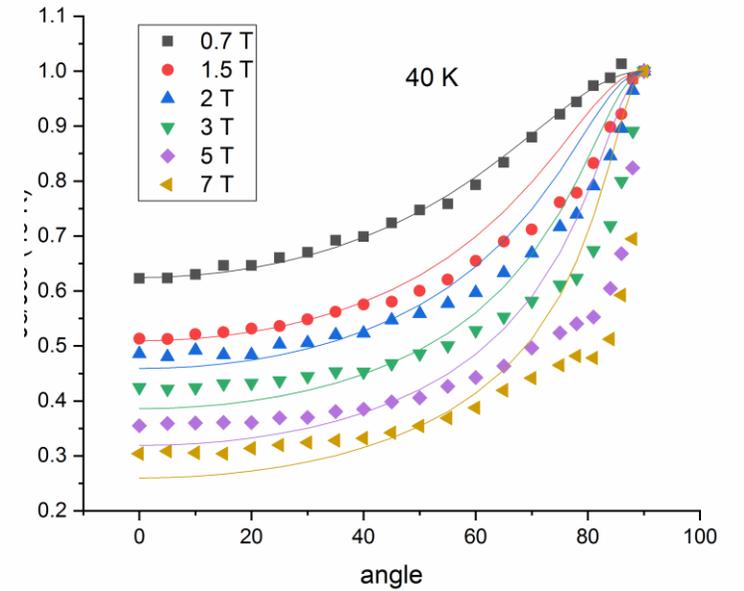
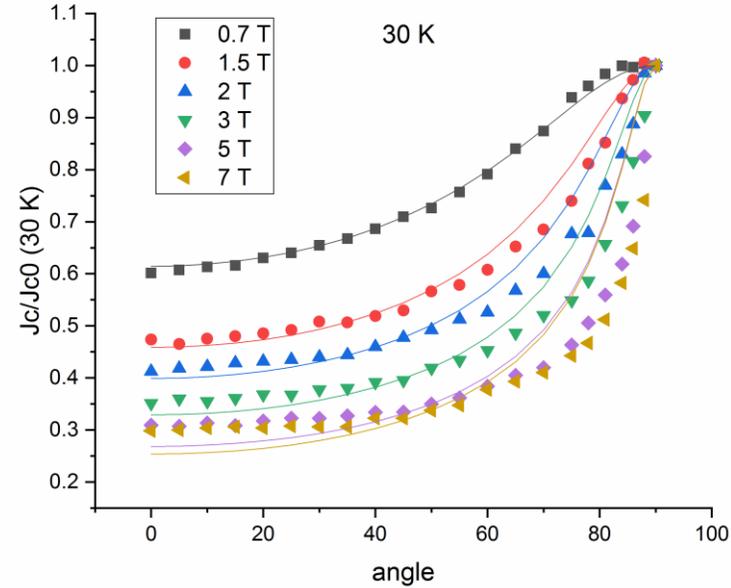
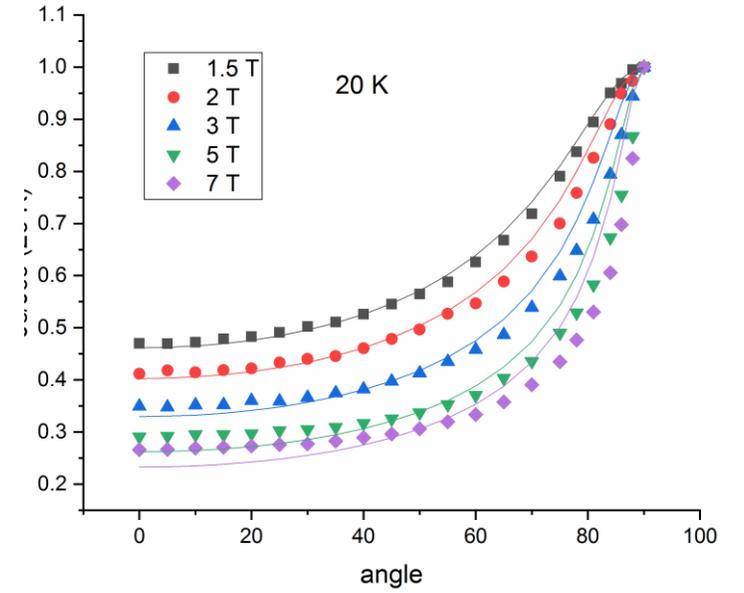
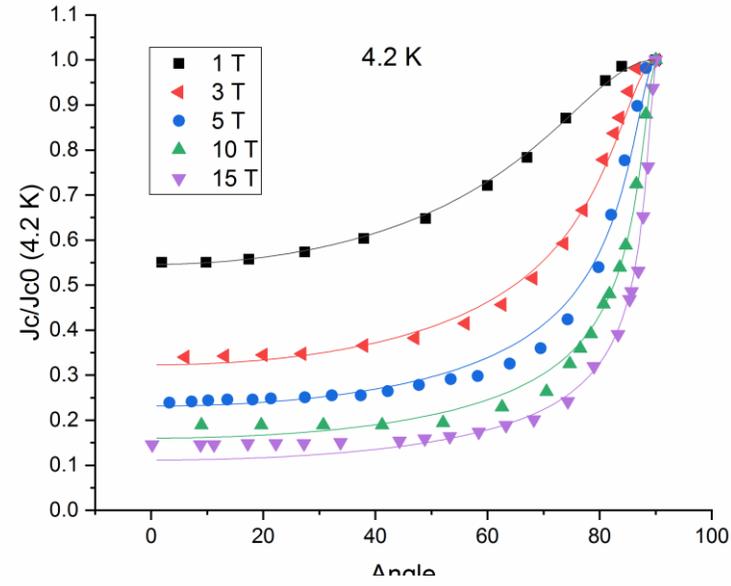
Thank you for your attention!



10. Quench Propagation



Fitting of J_c





Hydraulic

